

Overview

The purpose of this notification is to inform customers that Xilinx is adding a final test site in Taiwan for our products.

Description

Xilinx is adding final test capability with our current certified wafer sort test facility in Taiwan for product continuity. All Xilinx test programs will be transferred to this facility. There is no change to form, fit, function or reliability.

Products Affected

All Xilinx commercial (C), extended (E) and industrial (I) grade “XC” products are affected. Automotive “XA” PCN [XCN14009](#) will be issued on February 10th, 2014. Aerospace / Defense “XQ” and “XQR” devices are not affected at this time.

Key Dates and Ordering Information

Implementation will start upon release of this XCN notification.

Qualification Data

Xilinx has certified this additional test site and it meets all current Xilinx test requirements.

Response

No action is required as there is no change to fit, form, function or reliability.

Important Notice: Xilinx Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (<http://www.xilinx.com/support>). Register today and personalize your “Documentation and Design Advisory Alerts” area to include Customer Notifications. Xilinx Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to Answer Record 18683: <http://www.xilinx.com/support/answers/18683.htm>.

Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
11/04/13	1.0	Initial release.
02/10/14	1.1	Update the products affected section for Automotive "XA" device.

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